MTB29N15E

TMOS POWER FET

29 AMPERES

150 VOLTS

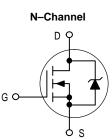
RDS(on) = 0.07 OHM

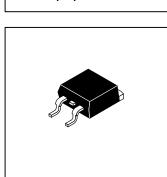
Product Preview **TMOS E-FET** ™ **Power Field Effect Transistor** N-Channel Enhancement-Mode Silicon Gate

This advanced TMOS E–FET is designed to withstand high energy in the avalanche and commutation modes. The new energy efficient design also offers a drain–to–source diode with a fast recovery time. Designed for low voltage, high speed switching applications in power supplies, converters and PWM motor controls, these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional safety margin against unexpected voltage transients.

- Avalanche Energy Specified
- Source-to-Drain Diode Recovery Time Comparable to a Discrete Fast Recovery Diode
- Diode is Characterized for Use in Bridge Circuits
- IDSS and VDS(on) Specified at Elevated Temperature







CASE 418B-03, Style 2 D²PAK

MAXIMUM RATINGS (T _C = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-to-Source Voltage	V _{DSS}	150	Vdc
Drain–to–Gate Voltage (R_{GS} = 1.0 M Ω)	VDGR	150	Vdc
Gate–to–Source Voltage — Continuous — Non–Repetitive (t _p ≤ 10 ms)	V _{GS} V _{GSM}	± 20 ± 40	Vdc Vpk
Drain Current — Continuous — Continuous @ 100°C — Single Pulse (t _p ≤ 10 μs)	I _D I _D I _{DM}	29 19 102	Adc Apk
Total Power Dissipation Derate above 25°C Total Power Dissipation @ T _A = 25°C ⁽¹⁾	PD	125 1.0 2.5	Watts W/°C Watts
Operating and Storage Temperature Range	TJ, Tstg	– 55 to 150	°C
Single Pulse Drain–to–Source Avalanche Energy — STARTING T _J = 25° C (V _{DD} = 25 Vdc, V _{GS} = 10 Vdc, PEAK I _L = 29 Apk, L = 1.0 mH, R _G = 25Ω)	EAS	421	mJ
Thermal Resistance — Junction to Case — Junction to Ambient — Junction to Ambient ⁽¹⁾	R _θ JC R _θ JA R _θ JA	1.0 62.5 50	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	ΤL	260	°C

(1) When surface mounted to an FR4 board using the minimum recommended pad size.

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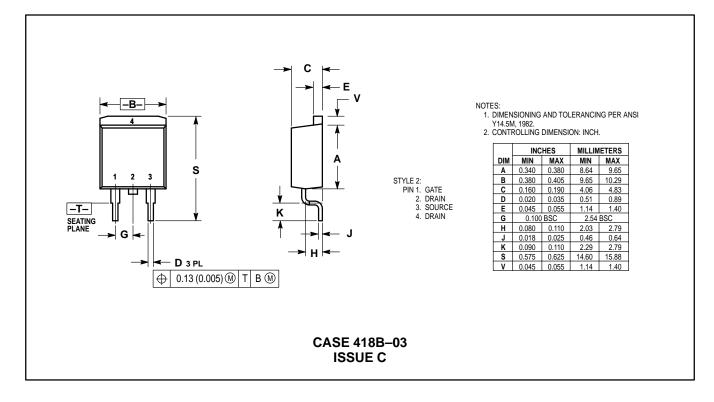
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Cha	racteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Drain–to–Source Breakdown Voltage ($V_{GS} = 0 \text{ Vdc}, I_D = 0.25 \text{ mAdc}$)		V(BR)DSS	150	_	_	Vdc
Temperature Coefficient (Positive	perature Coefficient (Positive)			TBD	—	mV/°C
Zero Gate Voltage Drain Current (VDS = 150 Vdc, VGS = 0 Vdc) (VDS = 150 Vdc, VGS = 0 Vdc, TJ = 125° C)		IDSS	_	_	10 100	μAdc
$(V_{DS} = 130 \text{ Vdc}, V_{GS} = 0 \text{ Vdc}, 13 = 123 \text{ C})$ Gate-Body Leakage Current (V_{GS} = ± 20 Vdc, V_{DS} = 0 Vdc)		I _{GSS}			100	nAdc
ON CHARACTERISTICS (1)		'635			100	11/100
		Veeu				Vdc
Gate Threshold Voltage $(V_{DS} = V_{GS}, I_D = 250 \mu Adc)$ Threshold Temperature Coefficient (Negative)		VGS(th)	2.0	2.7 TBD	4.0 —	mV/°C
Static Drain–to–Source On–Resistance ($V_{GS} = 10 \text{ Vdc}, I_D = 14.5 \text{ Adc}$)		R _{DS(on)}	_	0.055	0.07	Ohms
Drain-to-Source On-Voltage (VGS (ID = 29 Adc)	; = 10 Vdc)	V _{DS(on)}		_	2.4	Vdc
$(I_D = 14.5 \text{ Adc}, T_J = 125^{\circ}\text{C})$					2.1	
Forward Transconductance (V _{DS} =	8.6 Vdc, I _D = 14.5 Adc)	9FS	10	18	—	mhos
DYNAMIC CHARACTERISTICS						
Input Capacitance	(V _{DS} = 25 Vdc, V _{GS} = 0 Vdc,	C _{iss}		2250	3150	pF
Output Capacitance	f = 1.0 MHz	C _{oss}	_	455	910	
Transfer Capacitance		C _{rss}	—	133	190	
SWITCHING CHARACTERISTICS (2)			.		
Turn–On Delay Time	$ (V_{DD} = 75 \text{ Vdc}, \text{ I}_{D} = 29 \text{ Adc}, \\ V_{GS} = 10 \text{ Vdc}, \\ R_{G} = 9.1 \Omega) $	^t d(on)	_	17.5	40	ns
Rise Time		t _r	_	108	220	
Turn–Off Delay Time		^t d(off)	_	90	180	
Fall Time		t _f	—	85	170	
Gate Charge	(V _{DS} = 120 Vdc, I _D = 29 Adc, V _{GS} = 10 Vdc)	QT	_	78	110	nC
		Q ₁		12	—	
		Q ₂	_	37	—	
		Q3	_	23	—	
SOURCE-DRAIN DIODE CHARACT	TERISTICS					-
Forward On–Voltage	(I _S = 29 Adc, V _{GS} = 0 Vdc) (I _S = 29 Adc, V _{GS} = 0 Vdc, T _J = 125°C)	V _{SD}	_	0.92 TBD	1.3 —	Vdc
Reverse Recovery Time		t _{rr}		174		ns
	(I _S = 29 Adc, V _{GS} = 0 Vdc, dI _S /dt = 100 A/μs)	ta		140		
		ta t _b		34		
Reverse Recovery Stored Charge		Q _{RR}		1.4		μC
NTERNAL PACKAGE INDUCTANC	F	-111				
Internal Drain Inductance (Measured from the contact screw on tab to center of die) (Measured from the drain lead 0.25" from package to center of die)		LD		3.5 4.5		nH
Internal Source Inductance (Measured from the source lead 0.25" from package to source bond pad)		LS		7.5		

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
 Switching characteristics are independent of operating junction temperature.

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PACKAGE DIMENSIONS



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